IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- 10 µs Short Circuit Capability
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb–Free Devices

Typical Applications

- Solar Inverter
- UPS Inverter

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	30 15	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	120	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	l _F	30 15	A
Diode pulsed current, T _{pulse} limited by T _{Jmax}	I _{FM}	120	A
Gate-emitter voltage	V _{GE}	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	156 62.5	W
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, T_J \leq 150°C	T _{SC}	10	μs
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T _{stg}	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

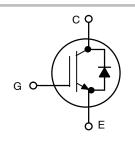
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

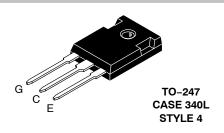


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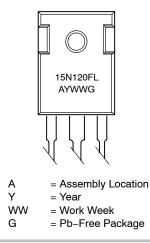
http://onsemi.com

15 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 0.55 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB15N120FLWG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

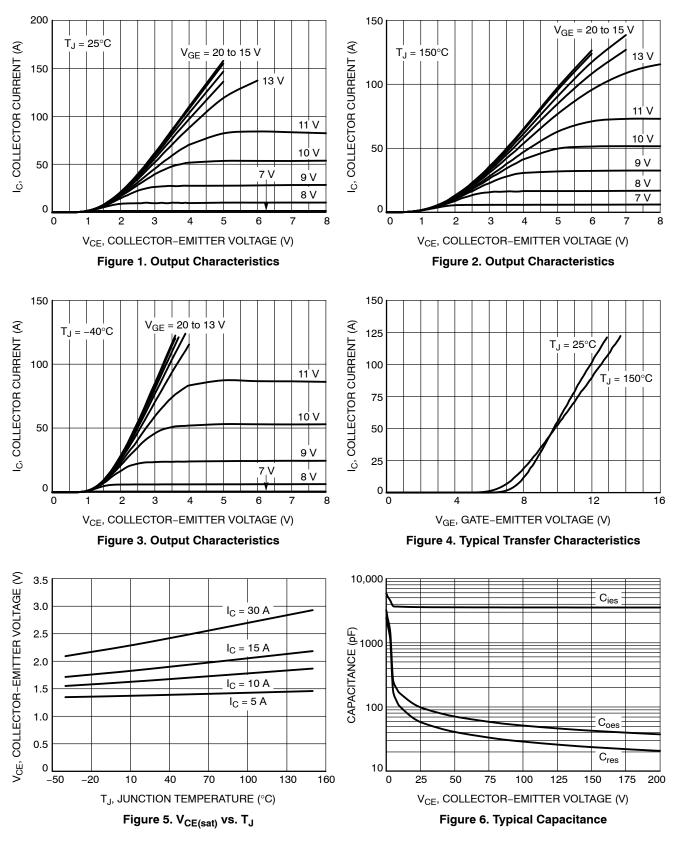
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.80	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

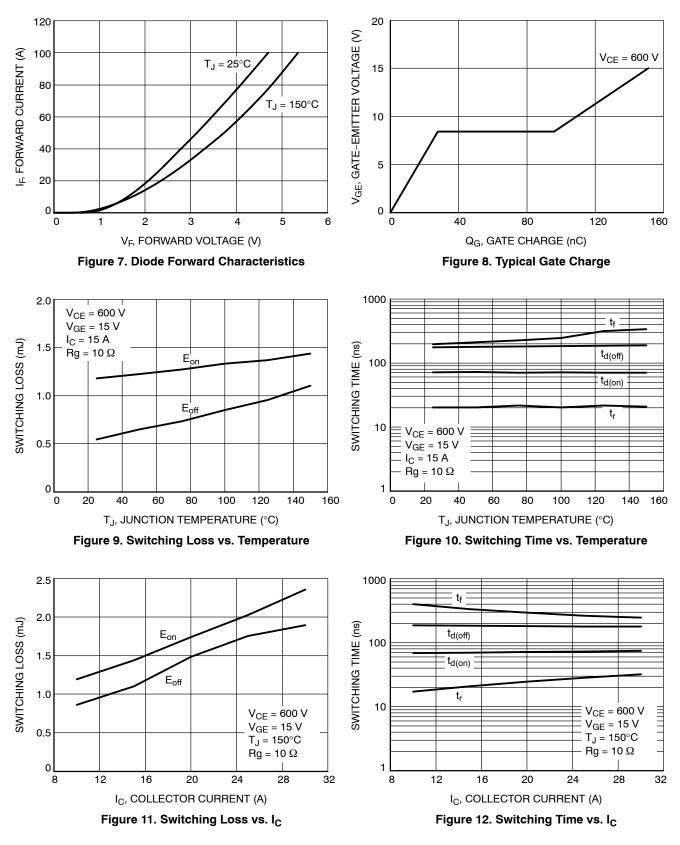
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

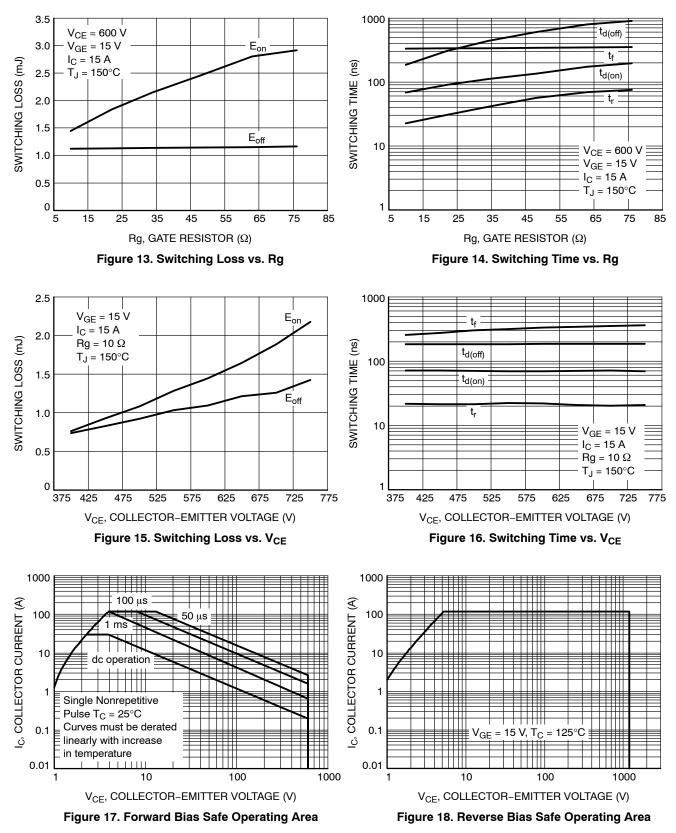
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	•				
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1200	_	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 15 A V_{GE} = 15 V, I _C = 15 A, T _J = 150°C	V _{CEsat}	1.5 _	2.0 2.2	2.2	V
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 150 μ A	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J =} 150^{\circ}C$	I _{CES}			0.35 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	-	_	100	nA
DYNAMIC CHARACTERISTIC	•	•				
Input capacitance		C _{ies}	-	3600	_	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	110	_	
Reverse transfer capacitance	1	C _{res}	-	66	_	
Gate charge total		Qg	-	150	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 15 A, V _{GE} = 15 V	Q _{ge}	-	28	-	
Gate to collector charge	1	Q _{gc}	-	68	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	72	-	ns
Rise time	1	t _r	-	19	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	168	_	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 15 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	194	-	
Turn-on switching loss	$V_{GE} = 0 V/15V$	Eon	-	1.17	-	mJ
Turn-off switching loss		E _{off}	-	0.55	-	
Total switching loss	1	E _{ts}	-	1.72	-	
Turn-on delay time		t _{d(on)}	-	70	-	ns
Rise time	7	t _r	-	21	-	
Turn-off delay time	T _J = 125°C	t _{d(off)}	-	175	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 15 \text{ A}$ $R_{a} = 10 \Omega$	t _f	-	310	-	
Turn-on switching loss	$R_g = 10 \Omega$ $V_{GE} = 0 V/ 15V$	E _{on}	-	1.35	-	mJ
Turn-off switching loss	7	E _{off}	-	0.96	-	
Total switching loss	7	E _{ts}	-	2.31	-	

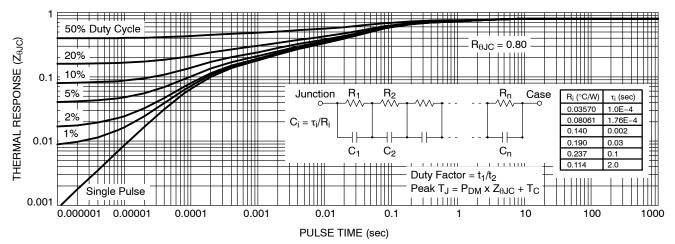
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTIC						
Forward voltage	$\label{eq:VGE} \begin{array}{l} V_{GE} = 0 \; V, I_F = 15 \; A \\ V_{GE} = 0 \; V, I_F = 15 \; A, T_J = 150^\circ C \end{array}$	V _F	1.5	1.8 2.5	2.2	V
Reverse recovery time	T _J = 25°C	t _{rr}	-	166	-	ns
Reverse recovery charge	I _F = 15 A, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}	-	1.1	-	μC
Reverse recovery current		I _{rrm}	-	12	-	А
Reverse recovery time	$T_J = 125^{\circ}C$	t _{rr}	-	200	-	ns
Reverse recovery charge	I _F = 15 A, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}	-	1.5	-	μο
Reverse recovery current		I _{rrm}	-	15	-	А











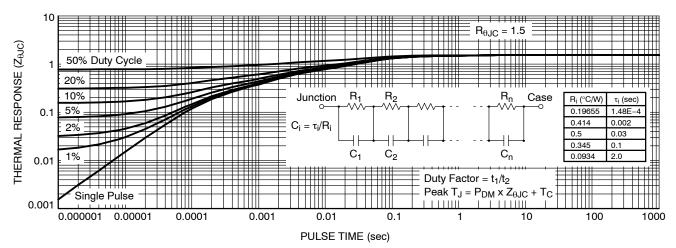


Figure 20. Diode Transient Thermal Impedance

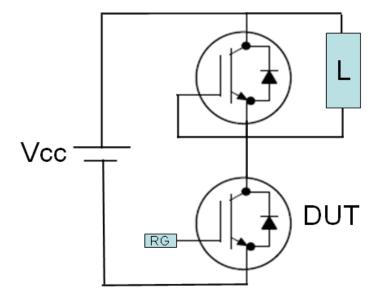
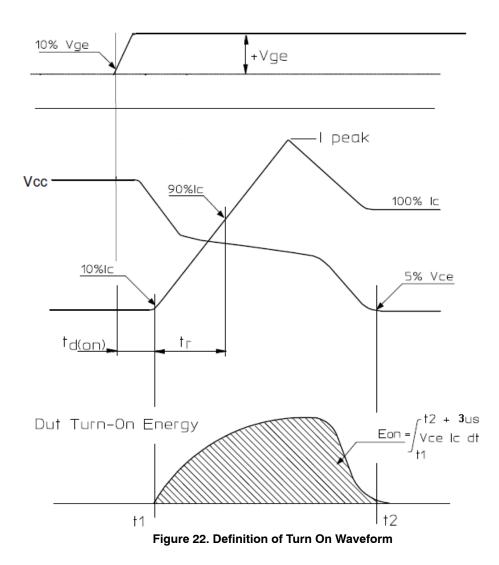


Figure 21. Test Circuit for Switching Characteristics



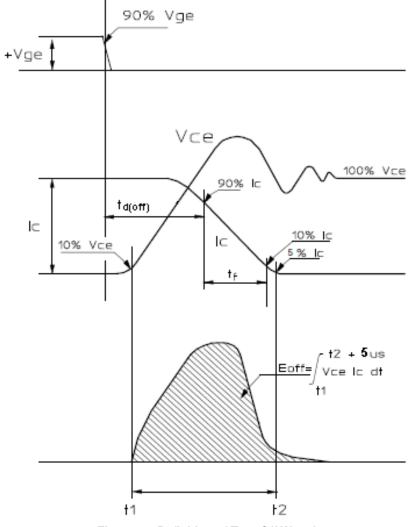


Figure 23. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

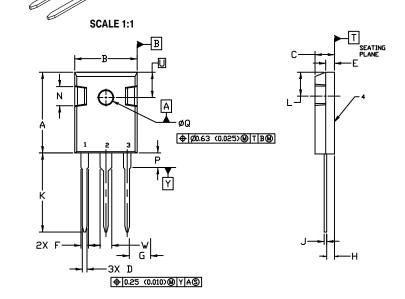
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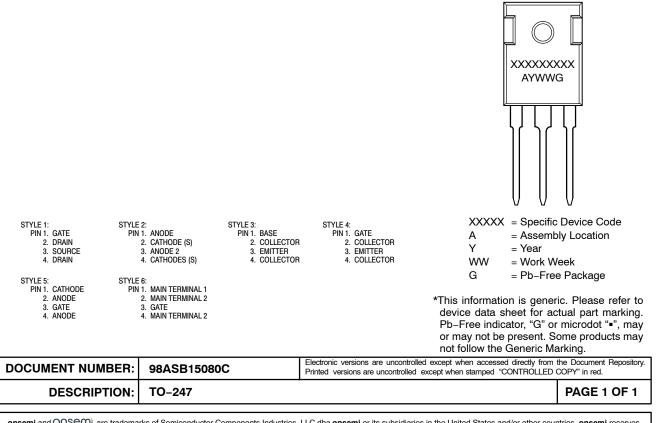


- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER



	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45	BSC	0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	BSC	0.242	BSC
V	2.87	3.12	0.113	0.123

GENERIC **MARKING DIAGRAM***



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